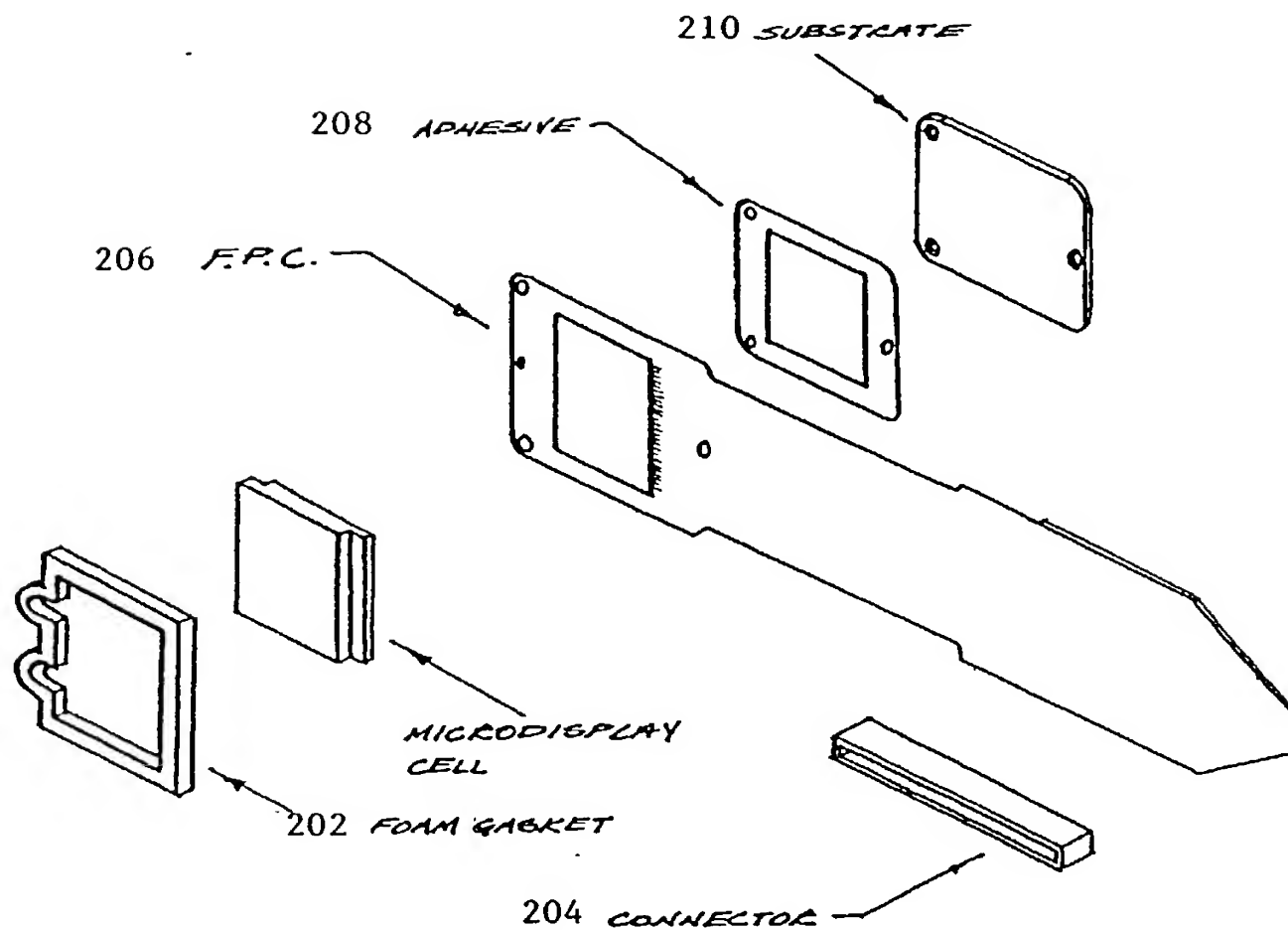


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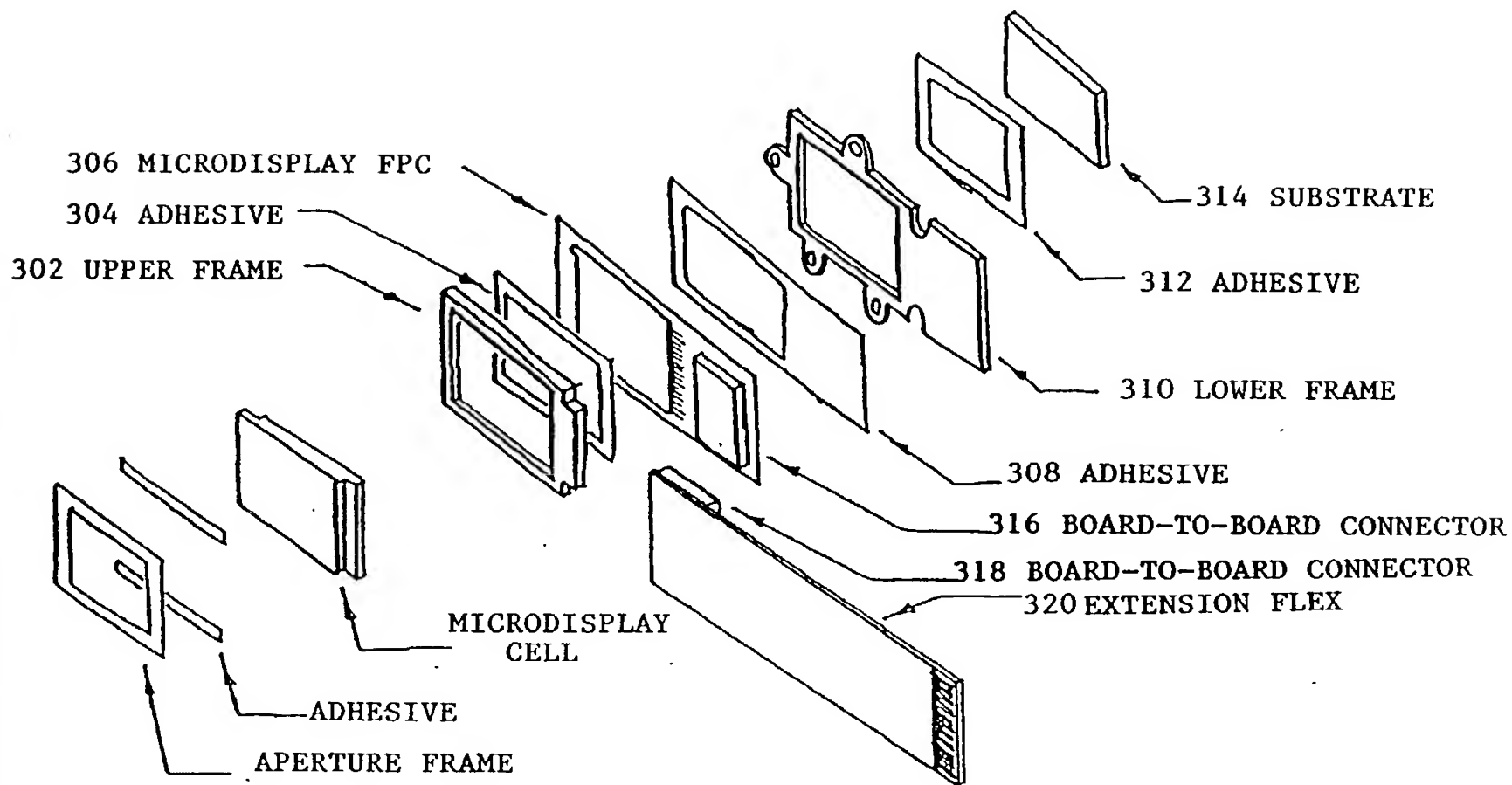
Figure 1: Exploded view of Art 1
(Prior Art)

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 ELECTRICALLY CONNECT TO A MICRODISPL



R. Edwards

Figure 2: Exploded view of Art 2.
 (Prior Art)



L. EDWARDS

Figure 3: Exploded view of Art 3.
(Prior Art)

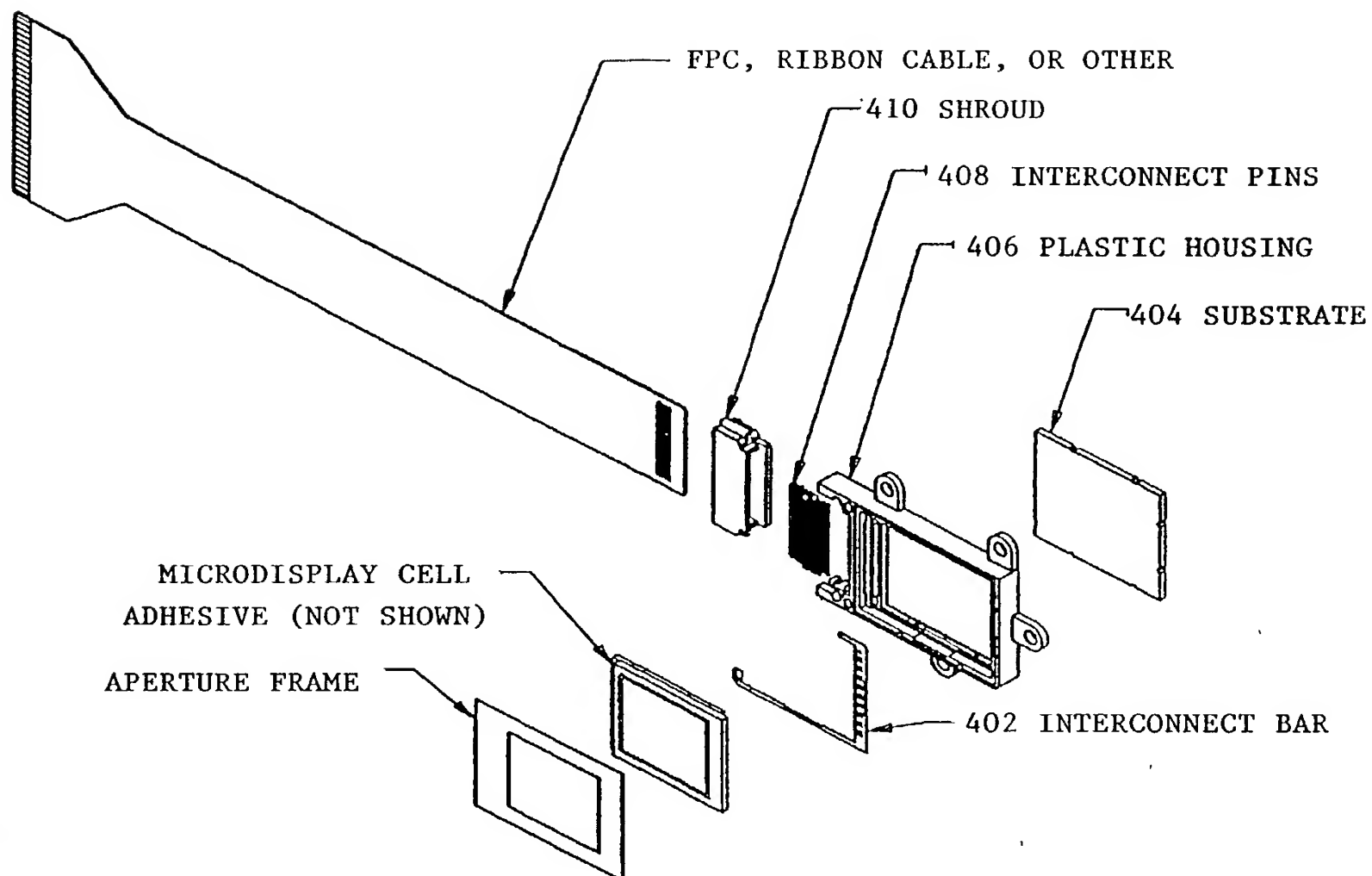


Figure 4: Exploded view of one Embodiment of the Invention

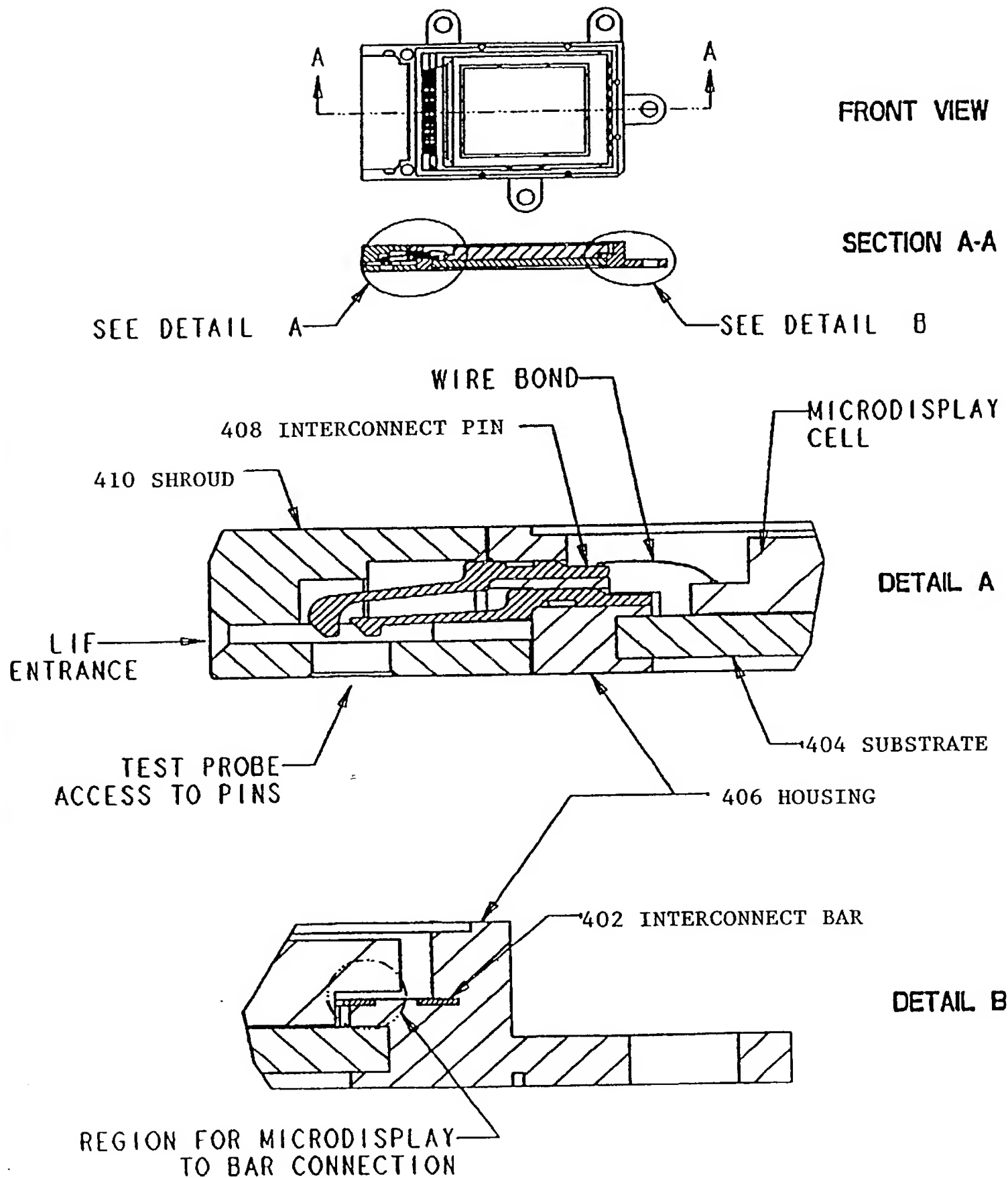


Figure 5: Detail A illustrates the pin to microdisplay wire bond and the test probe access to the Design's pins. Detail B shows the interconnect bar to microdisplay connection.